

ESDAxxSCx

Quad Transil™ array for ESD protection

Features

- 4 unidirectional Transil Functions
- Low leakage current: I_R max. < 20 µA at V_{RM}
- 400 W peak pulse power (8/20 µs)

Benefits

- High ESD protection level: up to 25 kV
- High integration
- Suitable for high density boards

Complies with the following standards:

- IEC 61000-4-2 level 4:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- MIL STD 883E- Method 3015-7: class3B
 - human body model

Applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Other telephone set
- Set top boxes

Description

The ESDAxxSC5 and ESDAxxSC6 are monolithic voltage suppressors designed to protect components which are connected to data and transmission lines against ESD.

They clamp the voltage just above the logic level supply for positive transients, and to a diode drop below ground for negative transient.

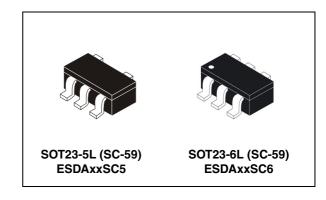


Figure 1. ESDAxxSC5 functional diagram

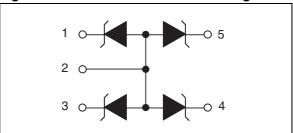
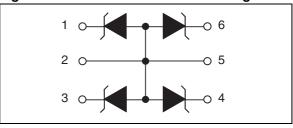


Figure 2. ESDAxxSC6 functional diagram



TM: Transil is a trademark of STMicroelectronics.

Characteristics ESDAxxSCx

1 Characteristics

Table 1. Absolute ratings ($T_{amb} = 25 \,^{\circ}C$)

Symbol		Value	Unit	
V _{PP}	MIL STD 883E - Method 3015-7 ESD discharge IEC61000-4-2 air discharge IEC61000-4-2 contact discharge		25	kV
		ESDA5V3SCx ESDA6V1SCx		w
P _{PP} Peak pulse power (8/20µs)	ESDA14V2SCx ESDA17SC6 ESDA19SC6 ESDA25SC6	300	W	
T _j	Junction temperature		150	°C
T _{stg}	Storage temperature range		-55 to +150	°C
T _L	Maximum lead temperature for soldering during 10 s at 5mm for case		260	°C
T _{op}	Operating temperature range	-40 to +125	°C	

Table 2. Electrical characteristics - definitions ($T_{amb} = 25$ °C)

Symbol	Parameter	ı
V_{RM}	Stand-off voltage	'F∤
V_{BR}	Breakdown voltage	
V_{CL}	Clamping voltage	V _{BR}
I _{RM}	Leakage current @ V _{RM}	VCL VRM VF
I _{PP}	Peak pulse current	IRM
αΤ	Voltage temperature coefficient	
С	Capacitance	
R _d	Dynamic resistance	Rd Ipp
V _F	Forward voltage dropt	

ESDAxxSCx Characteristics

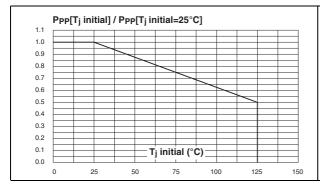
Table 3.	Electrical	characteristics -	values	$(T_{amb} = 25 ^{\circ}C)$

	V _{BR} @ I _R			I _{RM} @ V _{RM}		Rd	α Τ	С	V _F @ I _F	
Order codes	min.	max.		max.		typ. ⁽¹⁾	max. ⁽²⁾	typ. 0 V bias	max.	
	V	V	mA	μΑ	V	$\mathbf{m}\Omega$	10 ⁻⁴ /C	pF	V	mA
ESDA5V3SC5 ESDA5V3SC6	5.3	5.9	1	2	3	230	5	280	1.25	200
ESDA6V1SC5 ESDA6V1SC6	6.1	7.2	1	20	5.25	350	6	190	1.25	200
ESDA14V2SC5 ESDA14V2SC6	14.2	15.8	1	5	12	650	10	100	1.25	200
ESDA17SC6 ESDA19SC6	17 19	19 21	1	0.075 0.1	14 15	700 800	10 8.5	85 80	1.2 1.2	10 10
ESDA25SC6	25	30	1	1	24	1000	10	60	1.2	10

- 1. Square pulse, I_{pp} = 15 A, t_p =2.5 μ s.
- 2. \triangle VBR = α T* (T_{amb} -25 °C) * V_{BR} (25 °C)

Figure 3. Peak power dissipation versus initial junction temperature

Figure 4. Peak pulse power versus exponential pulse duration (Tj initial = 25 °C)



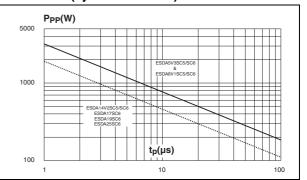
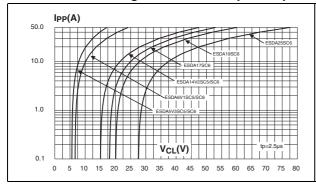


Figure 5. Clamping voltage versus peak pulse current (Tj initial = 25 °C). Rectangular waveform tp = 2.5 µs

Figure 6. Capacitance versus reverse applied voltage (typical values)



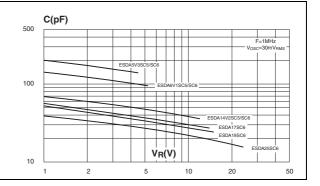
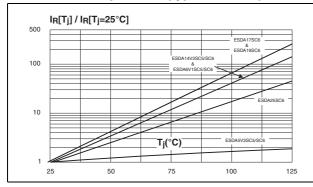
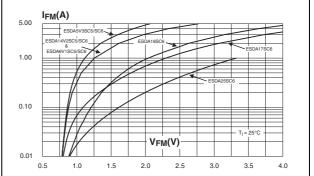


Figure 7. Relative variation of leakage current versus junction temperature (typical values)

Figure 8. Peak forward voltage drop versus peak forward current (typical values)





2 Application information

2.1 Calculation of the clamping voltage use of the dynamic resistance

The ESDA family has been designed to clamp fast spikes like ESD. Generally the PCB designers need to calculate easily the clamping voltage V_{CL} . This is why we give the dynamic resistance in addition to the classical parameters. The voltage across the protection cell can be calculated with the following formula:

$$V_{CL} = V_{BR} + R_d I_{PP}$$

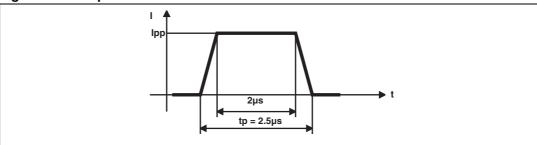
Where IPP is the peak current through the ESDA cell.

As the value of the dynamic resistance remains stable for a surge duration lower than 20 μ s, the 2.5 μ s rectangular surge is well adapted. In addition both rise and fall times are optimized to avoid any parasitic phenomenon during the measurement of R_d.

2.2 Dynamic resistance measurement

The short duration of the ESD has led us to prefer a more adapted test wave, as below defined, to the classical $8/20\mu s$ and $10/1000 \mu s$ surges.

Figure 9. 2.5 µs duration measurement wave



2.3 ESD protection with ESDAxxSCx

Electrostatic discharge (ESD) is a major cause of failure in electronic systems.

Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient overvoltage to a low enough level such that damage to the protected semiconductor is prevented.

Surface mount TVS arrays offer the best choice for minimal lead inductance.

They serve as parallel protection elements, connected between the signal line and ground. As the transient rises above the operating voltage of the device, the TVS array becomes a low impedance path diverting the transient current to ground.

ESD sensitive device

GND

ESDAXXSC6 (1connection to GND for ESDAXXSC5)

Figure 10. ESDAxxSCx array protection against ESD

The ESDAxxSCx array is the ideal board level protection of ESD sensitive semiconductor components.

The tiny SOT23-5L and SOT23-6L packages allow design flexibility in the high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening against ESD.

2.4 Advice for optimizing circuit board layout

Circuit board layout is a critical design step in the suppression of ESD induced transients. The following guidelines are recommended:

- The ESDAxxSC5/6 should be placed as close as possible to the input terminals or connectors.
- The path length between the ESD suppressor and the protected line should be minimized
- All conductive loops, including power and ground loops should be minimized
- The ESD transient return path to ground should be kept as short as possible
- Ground planes should be used whenever possible

Technical information ESDAxxSCx

3 Technical information

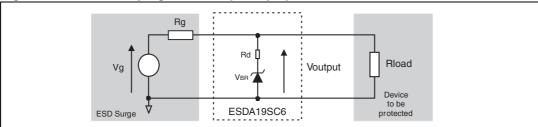
3.1 ESD protection

The ESDA19SC6 is particularly optimized to perform ESD protection. ESD protection is achieved by clamping the unwanted overvoltage. The clamping voltage is given by the following formula:

$$V_{CL} = V_{BR} + R_d \cdot I_{PP}$$

As shown in Figure 11., the ESD strikes are clamped by the transient voltage suppressor.

Figure 11. ESD clamping behavior (example)



To have a good approximation of the remaining voltages at both VI/O side, we provide the typical dynamical resistance value Rd. By taking into account the following hypothesis:

$$R_g > R_d$$
 and $R_{load} > R_d$

we have:

$$V_{output} = V_{BR} + R_d \times \frac{V_g}{R_g}$$

The results of the calculation done for V_g = 8 kV, R_g = 330 Ω (IEC61000-4-2 standard), V_{BR} = 19 V (typ.) and R_d = 0.80 Ω (typ.) give:

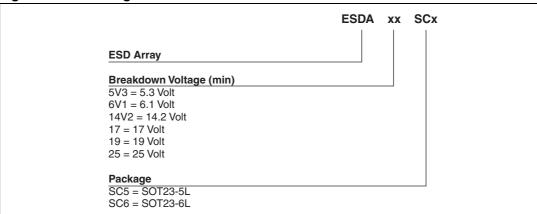
$$V_{\text{ouput}} = 38.4 \text{ V}$$

This confirms the very low remaining voltage across the device to be protected. It is also important to note that in this approximation the parasitic inductance effect was not taken into account. This could be a few tenths of volts during a few nanoseconds at the output side.

ESDAxxSCx Ordering information

4 Ordering information

Figure 12. Ordering information scheme



Package information ESDAxxSCx

5 Package information

Epoxy meets UL94, V0 standard

In order to meet environmental requirements, ST (also) offers these devices in ECOPACK® packages. ECOPACK® packages are Lead-free. The category of second level Interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

Max.

0.057

0.004

0.051

0.020

0.008

0.118

0.069

0.118

0.024

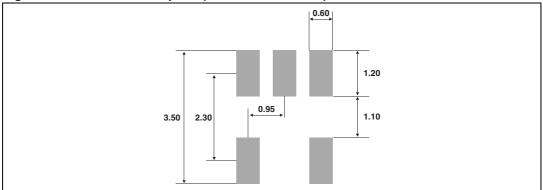
10°

ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Dimensions Ref. **Millimeters** Inches Min. Typ. Max. Min. Typ. 1.45 0.035 Α 0.90 Α1 0 0.10 0 0.90 1.30 0.035 Α2 0.35 0.50 0.014 b С 0.09 0.20 0.004 3.05 D 2.80 0.11 Α2 Е 1.50 1.75 0.059 0.95 0.037 е

Table 4. SOT23-5L dimensions





Н

L

2.60

0.10

0°

3.00

0.60

10°

0.102

0.004

0°

ESDAxxSCx Package information

Table 5. SOT23-6L dimensions

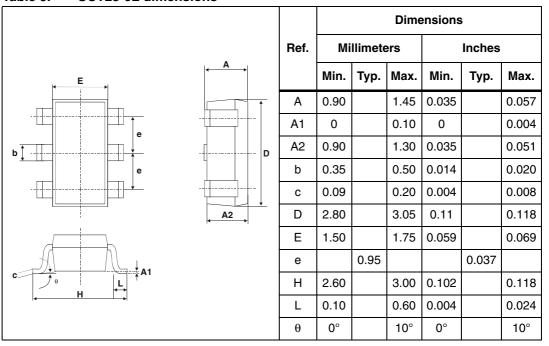
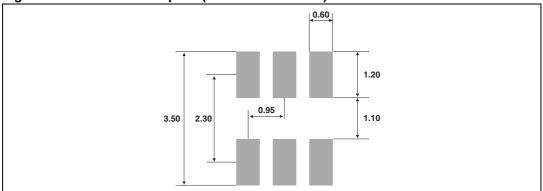


Figure 14. SOT23-6L footprint (dimensions in mm)



9/11

Ordering information ESDAxxSCx

6 Ordering information

 Table 6.
 Ordering information

Order codes	Marking	Package	Weight	Base qty	Delivery mode
ESDA5V3SC5	EC53				
ESDA6V1SC5	EC61	SOT23-5L	16.7 mg	3000	Tape and reel
ESDA14V2SC5	EC15				
ESDA5V3SC6	ES53	SOT23-6L			
ESDA6V1SC6	ES61				
ESDA14V2SC6	ES15				
ESDA17SC6	ES17				
ESDA19SC6	ES19				
ESDA25SC6	ES25				

7 Revision history

Table 7. Document revision history

•				
Date Revision		Description of changes		
Nov-2003	7F	Previous issue.		
4-Nov-2004	8	SOT23-6L package dimensions change for reference "D" from 3.0 millimeters (0.118 inches) to 3.05 millimeters (0.120 inches).		
22-Nov-2007	9	Reformatted to current standard. Units for I _{RM} MAX in <i>Table 3</i> corrected to µA. <i>Ordering information scheme</i> expanded to cover all devices. Package information for SOT23-5L updated.		

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com